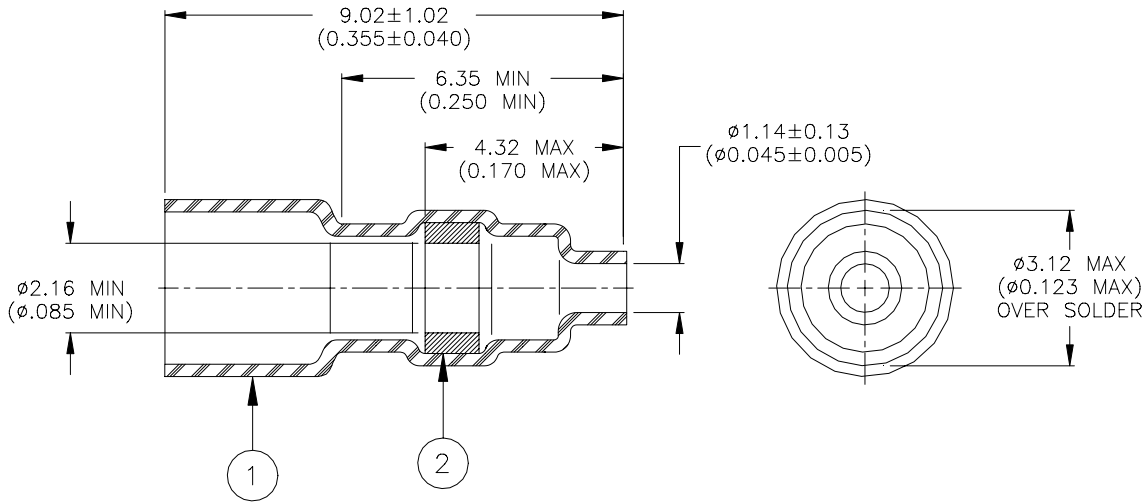


SPECIFICATION CONTROL DRAWING



MATERIALS

1. **INSULATION SLEEVE:** Heat shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
Recovered I.D.: 1.27 (0.050) max.
2. **SOLDER PREFORM WITH FLUX:**
SOLDER: TYPE Sn63 per ANSI J-STD-006.
FLUX: TYPE ROL1 per ANSI J-STD-004.

APPLICATION

1. This part is designed to attach a 24, 22, or 20 AWG conductor to a lead of an electrical component.
2. Sleeve may be installed using any heat source capable of raising the temperature of the substrates to be soldered to the soldering temperature without severely discoloring the insulation sleeve.
3. Wire and lead shall be inside the solder preform. Heat shall be applied until the solder melts and flows axially forming a fillet between the wire and the lead.

Raychem Interconnect <small>a division of tyco ELECTRONICS</small> 300 Constitution Drive Menlo Park, CA 94025, USA		THERMOFIT DEVICES		TITLE: SOLDERSLEEVE DISCRETE WIRE TERMINATOR			
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS. INCHES DIMENSIONS ARE BETWEEN BRACKETS.				DOCUMENT NO.: D-141-0228			
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A	ANGLES: N/A ROUGHNESS IN MICRON	Raychem reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.		DCR NUMBER: D000397		REPLACES: N/A	
DRAWN BY: M. FORONDA	DATE: 17-July-00	PROD. REV. A	DOC ISSUE: 1	SCALE: None	SIZE: A	SHEET: 1 of 1	

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